

TO

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
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APPLICABLE STANDARD				
RATING	OPERATING TEMPERATURE RANGE	-35 °C TO +85 °C(NOTE1)	STORAGE TEMPERATURE RANGE	-10 °C TO +60 °C
	VOLTAGE	250 V AC	APPLICABLE CONNECTOR	DF1B-*S-2.5R
	CURRENT	3 A		

SPECIFICATIONS				
ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS				
CONTACT RESISTANCE	100 mA (DC OR 1000 Hz).	30 mΩ MAX.	X	—
INSULATION RESISTANCE	500 V DC.	1000 MΩ MIN.	X	—
VOLTAGE PROOF	650 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	30 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
SHOCK	490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② CONTACT RESISTANCE: 30 mΩ MAX. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
ENVIRONMENTAL CHARACTERISTICS				
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35 °C TIME 30→ 5 MAX→ 30→ 5 MAX min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 1000 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 ~ 95 %, 96 h.	① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 1000 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE, 260 °C FOR IMMERSION, DURATION, 5 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE : 300 °C, SOLDERING TIME : 3 sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 235 °C FOR INSERTION DURATION, 5 s.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMersed.	X	—
REMARKS				
NOTE1: INCLUDE THE TEMPERATURE RISING BY CURRENT.		DRAWN	DESIGNED	CHECKED
		F.Matsuki	H. Umehara	T. Miyazaki
Unless otherwise specified, refer to JIS C 5402.		'04.03.25	'04.03.25	'04.03.25
Note QT:Qualification Test AT:Assurance Test X:Applicable Test		APPROVED		
		J. Ona		
PART NO.		RELEASED		
DF1BZ- * P-2.5DS				
CODE NO.(OLD)	DRAWING NO.	PART NO.		
CL	ELC4-305814-01	CL541	1/1	